

FEATURES

- Widely used in all kinds of battery packs
- High degree of inrush current capability
- Precise melting time
- Surface mount technology allows fuses to be directly attached to printed circuit boards
- Notebook Computer Wireless Base Station Networking Telecom System
- Significant savings in weight and real estate
- RoHS / REACH / AEC-Q200

RS PRO, Fuse, Ceramic SMD LTCC Chip Fuse, Slow Blow, 1A-20A 125V, 1206

RS Stock No.: 2522150 2522151



RS Professionally Approved Products bring to you professional quality parts across all product categories. Our product range has been tested by engineers and provides a comparable quality to the leading brands without paying a premium price.

Surface Mount Fuse — LTCC Chip Fuse



Product Description

Ceramic SMD LTCC Chip Fuse, Slow Blow, 1A-20A, 1206 Applications:

- Cooling Fan System
- Battery Management System (Battery Pack)

General Specifications

| Current Rating | 1A - 8A | 10A, 12A, 15A, 20A | |
|-----------------------|-----------------|--------------------------------|--|
| Voltage Rating | 63V | 24V | |
| Body Material | Ceramic | | |
| Interrupting Patings | 1A – 8A | 100A @ 63V DC 50A @ 125V DC | |
| Interrupting Ratings | 10A – 20A | 150A @ 24V DC | |
| Operating Temperature | -55°C to +125°C | | |
| Country of Origin | Taiwan | | |

Electrical Characteristics

| | | Opening Time | | | | |
|------------------|------|--------------|---------|-------|----------|--|
| Rated Current | 1 In | 2 In | | 3 In | 10 In | |
| Current | Min. | Min. | Max. | Max. | Max. | |
| 2A-8A | 4 hr | 1 sec | 120 sec | 3 sec | 0.05 sec | |

Surface Mount Fuse — LTCC Chip Fuse



I²t Nominal Cold Resistance & I²t &Safety Approval:

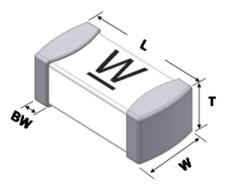
| Approvals | Marking | Interrupting rating | c FL [®] us | Nominal Cold Resistance (Ohms) | Nominal Melting I ² t (A ² sec.) |
|-----------|-----------|--------------------------------|-----------------------------|-----------------------------------|--|
| 1A | <u>H</u> | 100A @ 63V DC 50A @ 125V DC | * | 0.1610 - 0.2990 | 0.170 |
| 1.5A | <u>K</u> | | * | 0.0875 - 0.1625 | 0.394 |
| 2A | <u>N</u> | | * | 0.0525 - 0.0975 | 0.720 |
| 2.5A | <u>0</u> | | * | 0.0350 - 0.0650 | 0.938 |
| 3A | <u>P</u> | | * | 0.0224 - 0.0416 | 1.350 |
| 4A | <u>s</u> | | * | 0.0126 - 0.0234 | 2.240 |
| 5A | Ī | | * | 0.0091 - 0.0169 | 3.000 |
| 6A | <u>U</u> | | * | 0.0063 - 0.0117 | 4.680 |
| 7A | V | | * | 0.0056 - 0.0104 | 6.370 |
| 8A | <u>w</u> | | * | 0.0049 - 0.0091 | 8.320 |
| 10A | <u>10</u> | 150A @ 24V DC | * | 0.0042 - 0.0078 | 12.00 |
| 12A | <u>12</u> | | * | 0.0035 - 0.0065 | 17.28 |
| 15A | <u>15</u> | | * | 0.0021 - 0.0039 | 29.25 |
| 20A | <u>20</u> | | * | 0.0014 - 0.0026 | 52.00 |

Surface Mount Fuse — LTCC Chip Fuse



Shape & Dimension:

| Туре | 1206 | |
|------|---------------|--|
| L | 3.1 ± 0.2 mm | |
| W | 1.6 ± 0.2 mm | |
| Т | 0.9 ± 0.2 mm | |
| BW | 0.5 ± 0.25 mm | |



| Recommended Pad Layout | |
|-------------------------------|---------|
| L1 | 1.10 mm |
| L2 | 1.52 mm |
| W | 1.78 mm |

